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(12) **United States Design Patent**  
**Podubni**

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- (54) **MODULAR CIRCUIT BOARD**
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- (73) Assignee: **TinyPCB, Inc.**
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- (52) **U.S. Cl.**  
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H05K 3/363; H05K 3/40; H05K 7/14;  
H05K 7/1422; H05K 7/00; H05K 1/18;  
H05K 1/02; H05K 1/181; H05K 1/182;  
H05K 1/183; H05K 1/184; H05K 1/189;  
H05K 1/00  
See application file for complete search history.

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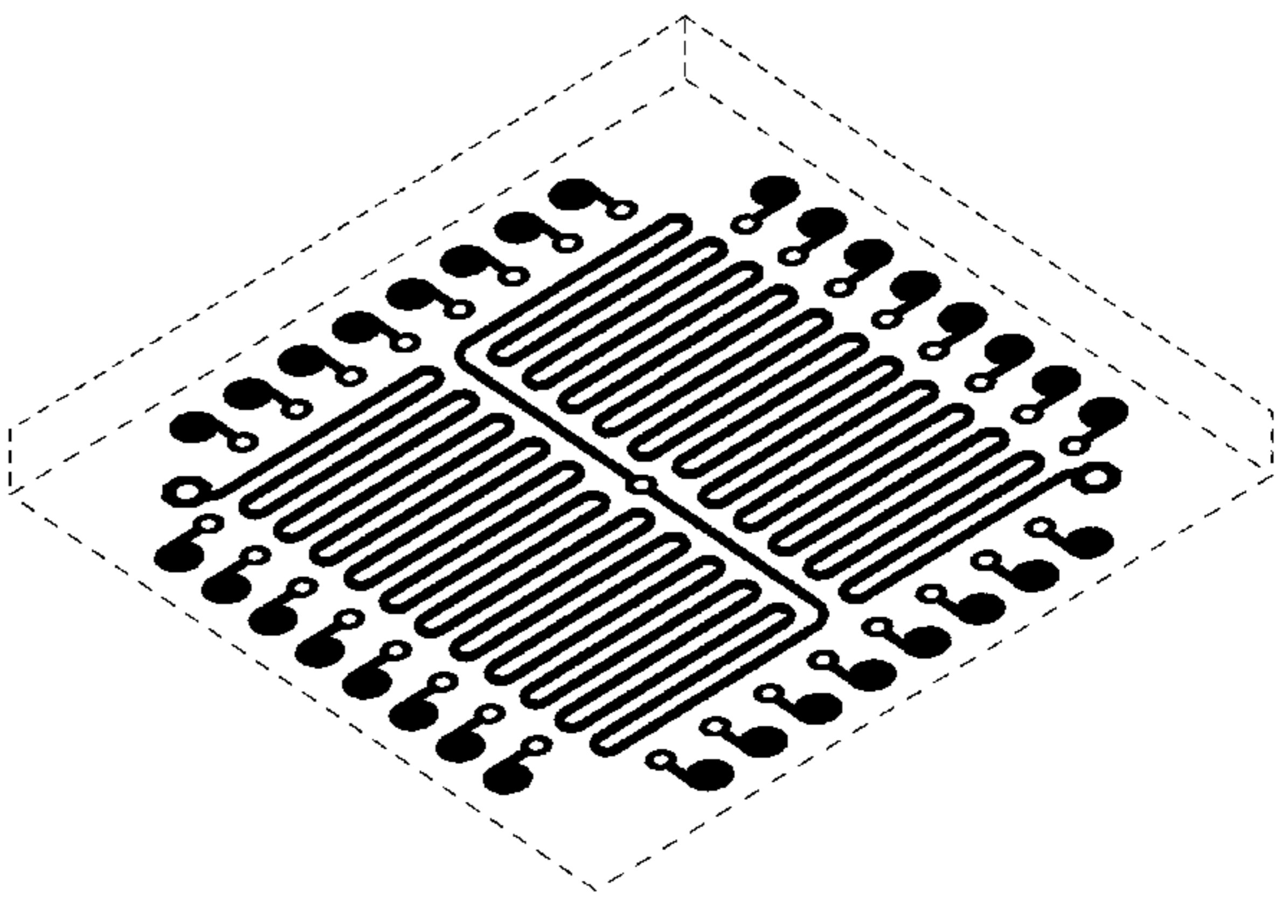
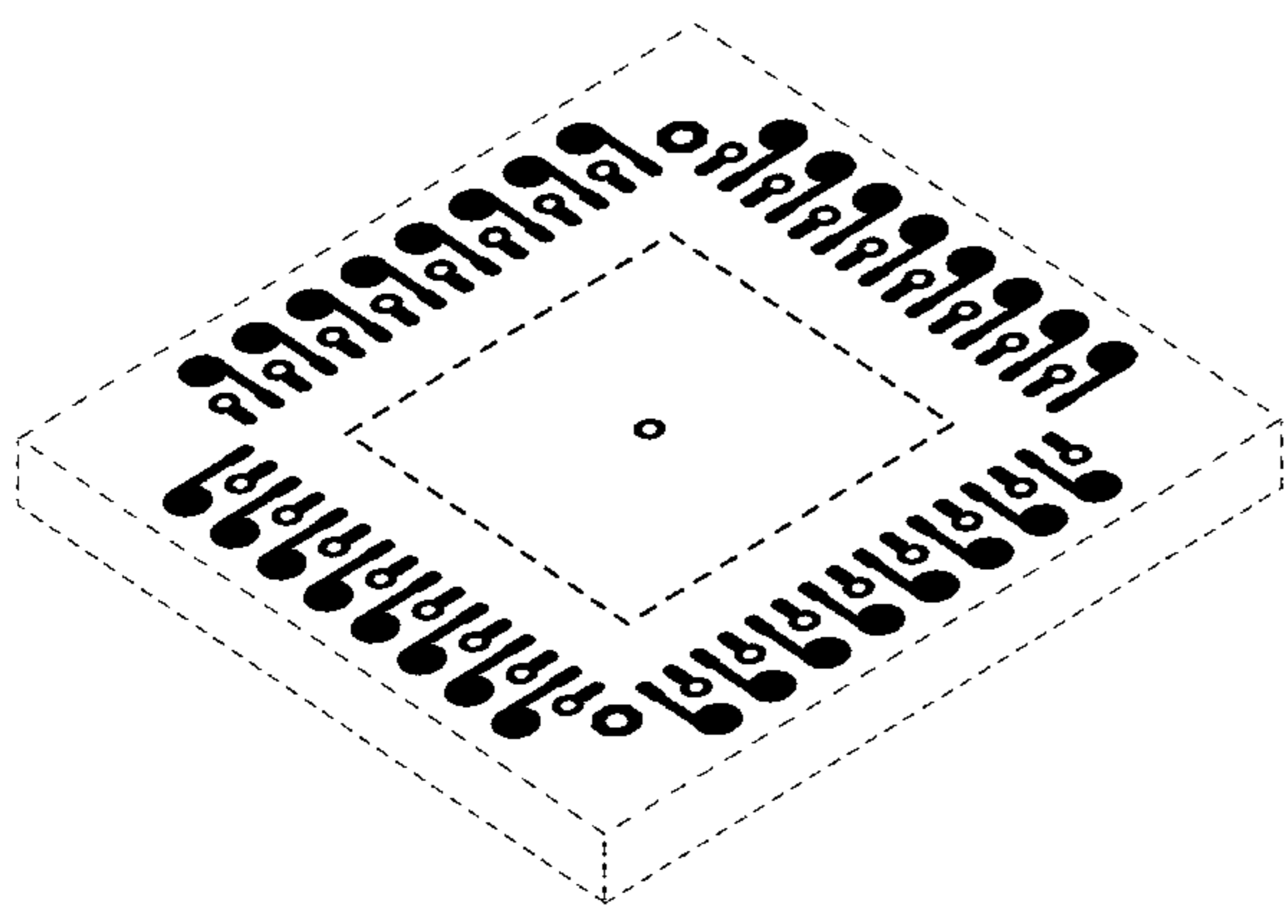
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(57) **CLAIM**  
The ornamental design for a modular circuit board, as shown and described.

**DESCRIPTION**  
FIG. 1 is a top perspective view of a modular circuit board, showing my new design;  
FIG. 2 is a bottom perspective view thereof;  
FIG. 3 is a top view thereof;  
FIG. 4 is a bottom view thereof; and,  
FIG. 5 is a side view thereof, all other side views being a mirror image thereof.  
The broken lines shown in the drawings represent portions of the modular circuit board that form no part of the claimed design.

**1 Claim, 5 Drawing Sheets**



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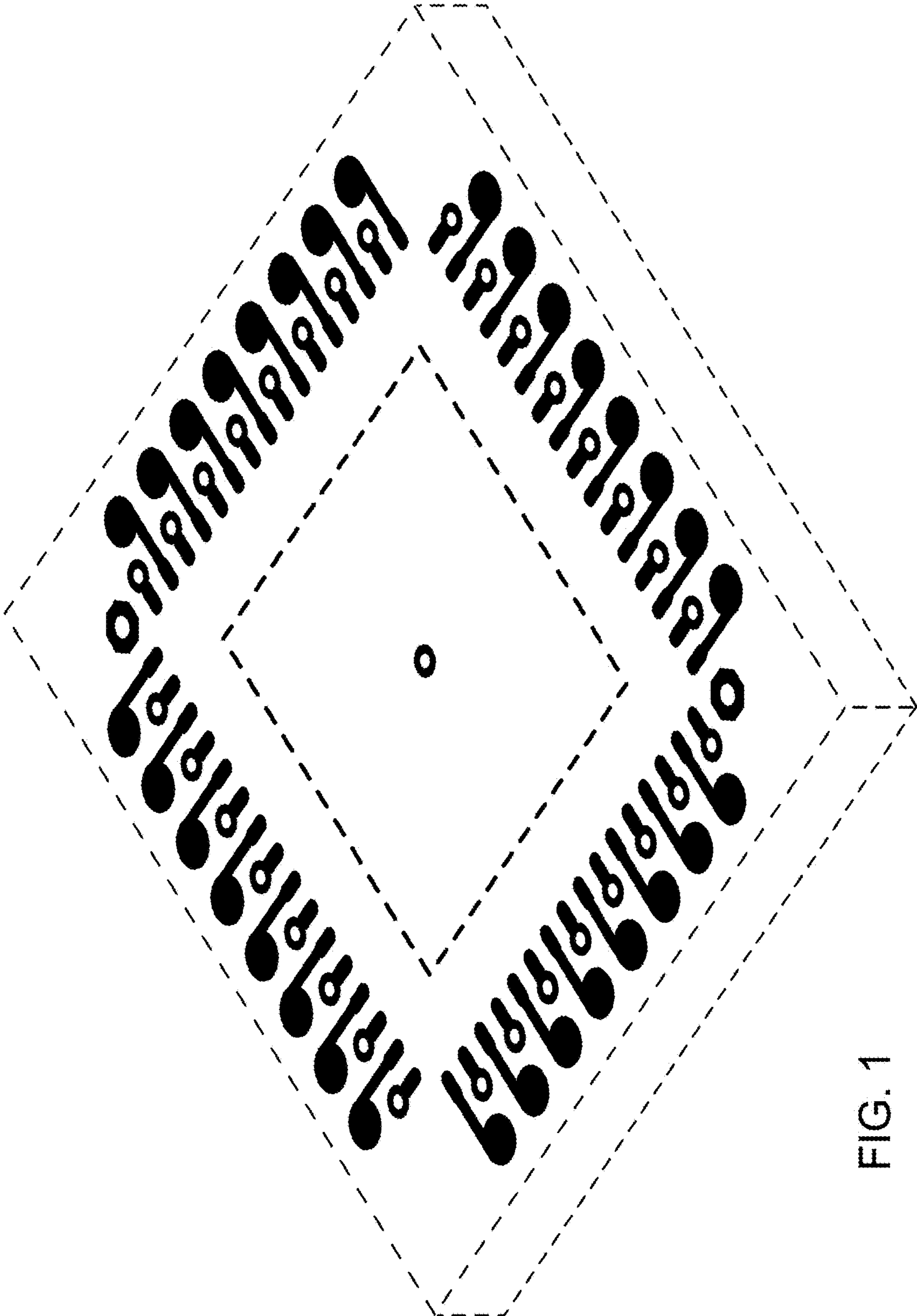


FIG. 1

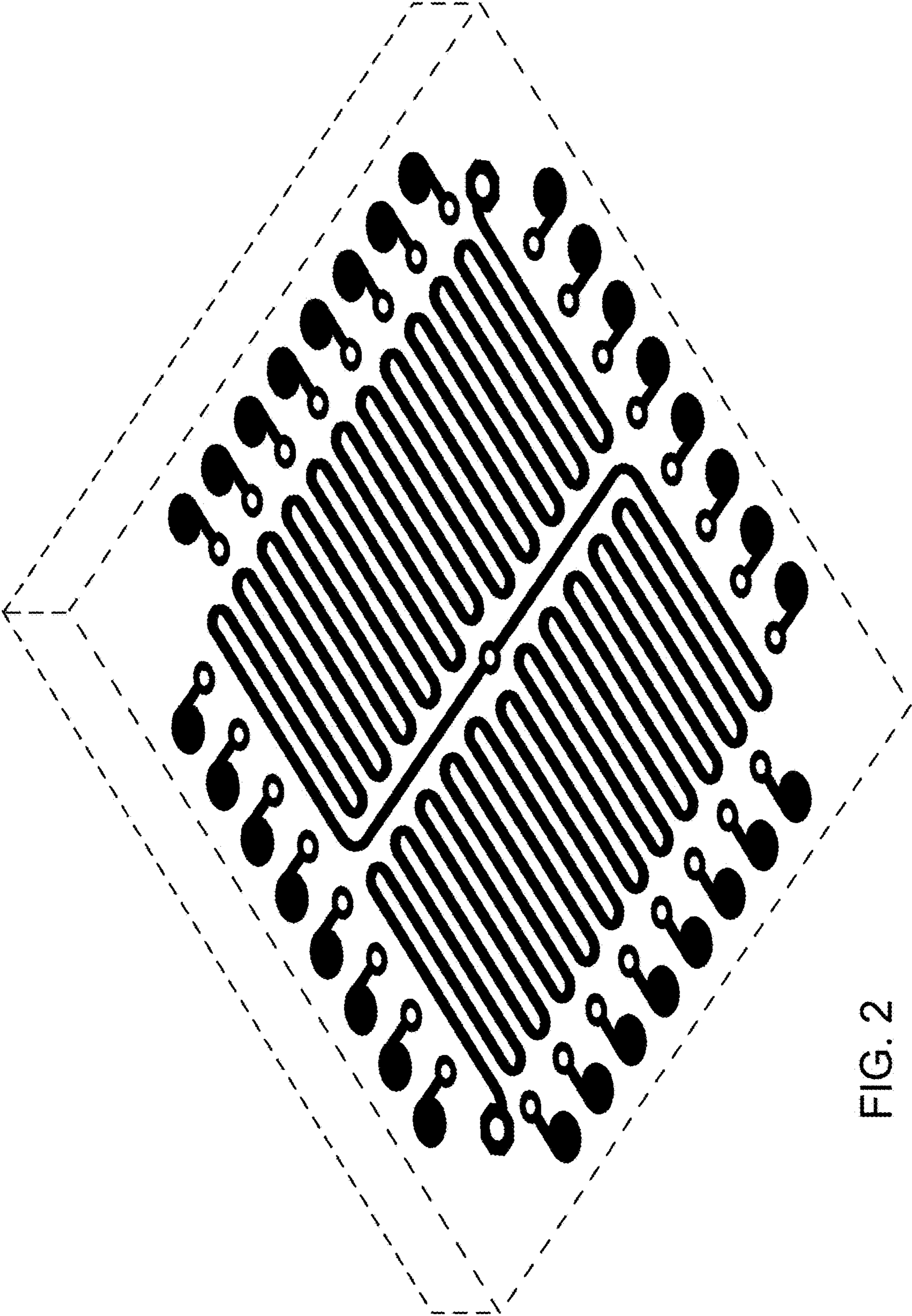


FIG. 2

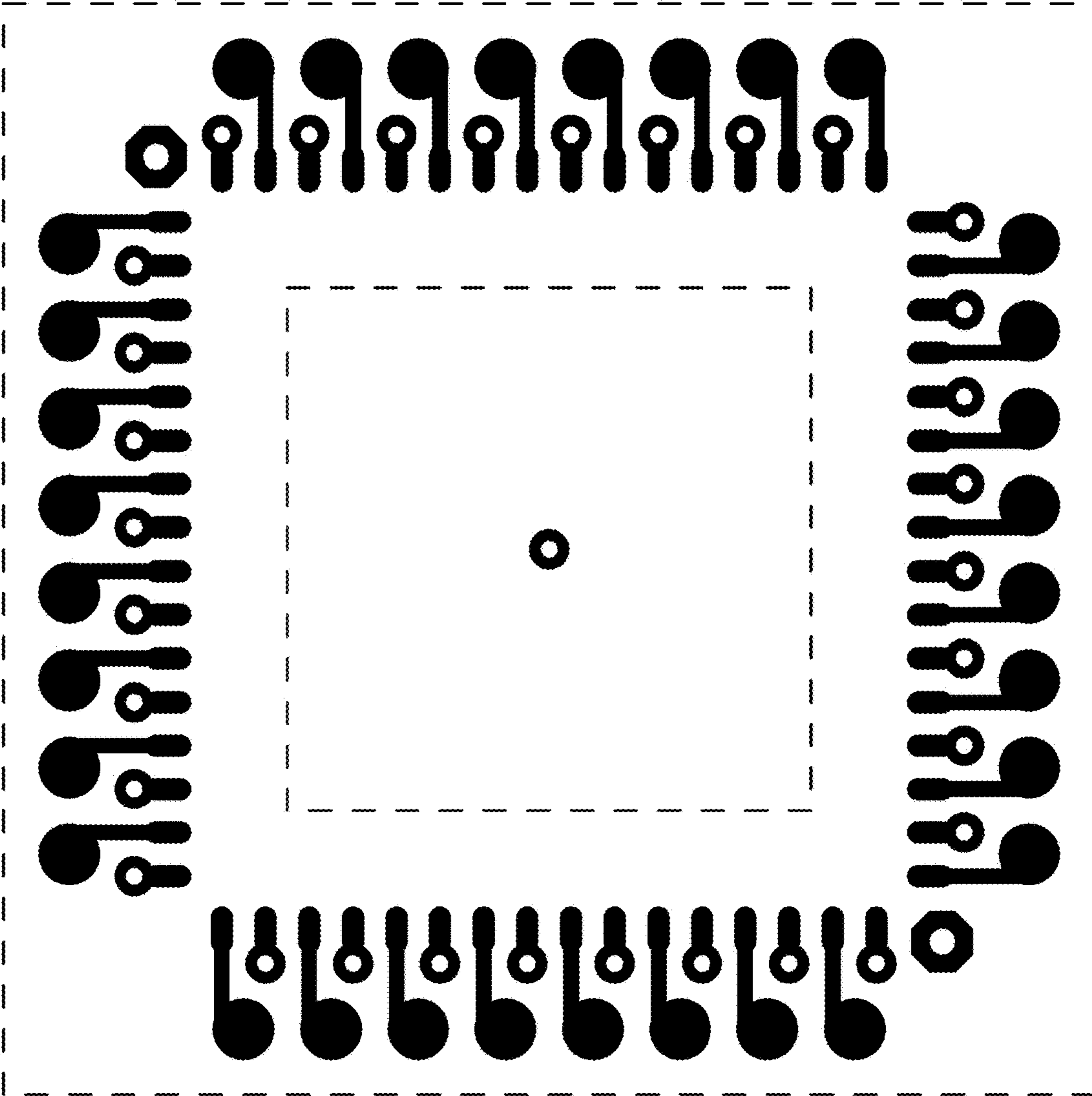


FIG. 3

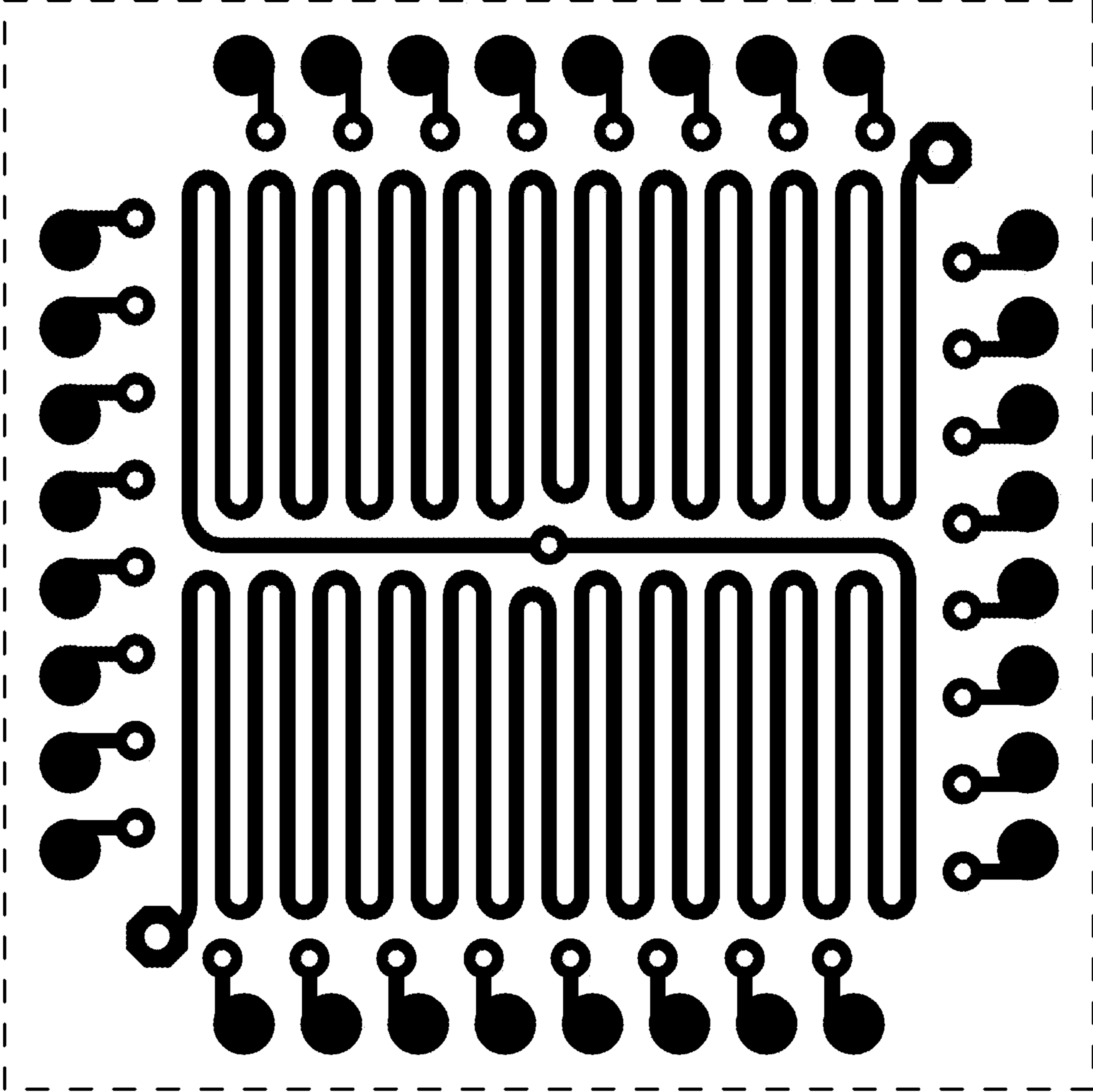


FIG. 4



FIG. 5